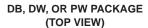
# SN74LVCC3245A-EP OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

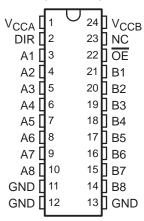
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- Controlled Baseline
  - One Assembly/Test Site, One Fabrication Site
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree<sup>†</sup>
- Bidirectional Voltage Translator
- 2.3 V to 3.6 V on A Port and 3 V to 5.5 V on B Port
- Control Inputs V<sub>IH</sub>/V<sub>IL</sub> Levels Are Referenced to V<sub>CCA</sub> Voltage
- Latch-Up Performance Exceeds 250 mA Per JESD 17

#### ESD Protection Exceeds JESD 22

- 2000-V Human-Body Model (A114-A)
- 200-V Machine Model (A115-A)
- 1000-V Charged-Device Model (C101)





NC - No internal connection

### description/ordering information

This 8-bit (octal) noninverting bus transceiver contains two separate supply rails. The B port is designed to track  $V_{CCB}$ , which accepts voltages from 3 V to 5.5 V, and the A port is designed to track  $V_{CCA}$ , which operates at 2.3 V to 3.6 V. This allows for translation from a 3.3-V to a 5-V system environment and vice versa, from a 2.5-V to a 3.3-V system environment and vice versa.

The SN74LVCC3245A is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the device so the buses are isolated. The control circuitry (DIR,  $\overline{OE}$ ) is powered by  $V_{CCA}$ .

#### ORDERING INFORMATION

TA	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SOIC - DW	Reel of 2000	CLVCC3245AIDWREP	LVCC3245A
-40°C to 85°C	SSOP - DB	Reel of 2000	CLVCC3245AIDBREP	LH245AEP
	TSSOP - PW	Reel of 2000	CLVCC3245AIPWREP	LH245AEP

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



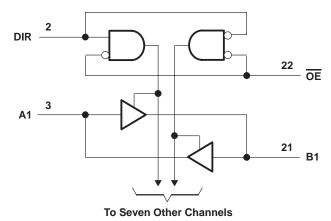
<sup>†</sup> Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

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#### **FUNCTION TABLE** (each transceiver)

INP	UTS	0050471011
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Χ	Isolation

### logic diagram (positive logic)



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, $V_{CCA}$ and $V_{CCB}$ .  Input voltage range, $V_{I}$ : All A ports (see Note 1)	$5 \text{ V to V}_{\text{CCA}} + 0.5 \text{ V}$ $5 \text{ V to V}_{\text{CCB}} + 0.5 \text{ V}$ $5 \text{ V to V}_{\text{CCA}} + 0.5 \text{ V}$ $5 \text{ V to V}_{\text{CCA}} + 0.5 \text{ V}$
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–50 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Continuous output current, I <sub>O</sub>	±50 mA
Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND	±100 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): DB package	63°C/W
DW package	46°C/W
PW package	88°C/W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. This value is limited to 4.6 V maximum.
  - 2. This value is limited to 6 V maximum.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.



# SN74LVCC3245A-EP OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS SCAS773A – JUNE 2004 – REVISED MARCH 2005

### recommended operating conditions (see Note 4)

		VCCA	VCCB	MIN	NOM	MAX	UNIT
VCCA	Supply voltage			2.3	3.3	3.6	V
Vссв	Supply voltage			3	5	5.5	V
		2.3 V	3 V	1.7			
.,	LPark Level Construction	2.7 V	3 V	2			
$V_{IHA}$	High-level input voltage	3 V	3.6 V	2			V
		3.6 V	5.5 V	2			
		2.3 V	3 V	2			
\/	High level involvations	2.7 V	3 V	2			V
VIHB	High-level input voltage	3 V	3.6 V	2			V
		3.6 V	5.5 V	3.85			
VILA		2.3 V	3 V			0.7	
	Low level input voltage		3 V			0.8	V
	Low-level input voltage	3 V	3.6 V			0.8	V
		3.6 V	5.5 V			0.8	
		2.3 V	3 V			0.8	V
V	Low-level input voltage	2.7 V	3 V			8.0	
$V_{ILB}$	Low-level input voltage	3 V	3.6 V			8.0	
		3.6 V	5.5 V			1.65	
		2.3 V	3 V	1.7			
$V_{IH}$	High-level input voltage (control pins)	2.7 V	3 V	2			V
٧IH	(Referenced to V <sub>CCA</sub> )	3 V	3.6 V	2			V
		3.6 V	5.5 V	2			
		2.3 V	3 V			0.7	
VIL	Low-level input voltage (control pins)	2.7 V	3 V			0.8	V
۷IL	(Referenced to V <sub>CCA</sub> )	3 V	3.6 V			0.8	V
		3.6 V	5.5 V			8.0	
$V_{IA}$	Input voltage			0		VCCA	V
$V_{IB}$	Input voltage			0		VCCB	V
$V_{OA}$	Output voltage			0		VCCA	V
VOB	Output voltage			0		VCCB	V

NOTE 4: All unused inputs of the device must be held at the associated V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN74LVCC3245A-EP OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

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### recommended operating conditions (see Note 4) (continued)

		VCCA	V <sub>CCB</sub>	MIN	NOM	MAX	UNIT
		2.3 V	3 V			-8	
IOHA	High-level output current	2.7 V	3 V			-12	mA
		3.3 V	3 V			-24	
		2.3 V	3.3 V			-12	
IOHB	High-level output current	2.7 V	3.3 V			-12	mA
		3.3 V	3 V			-24	
		2.3 V	3 V			8	
IOLA	Low-level output current	2.7 V	3 V			12	mA
		3.3 V	3 V			24	
		2.3 V	3.3 V			12	
IOLB	Low-level output current	2.7 V	3.3 V			12	mA
			3 V			24	
Δt/Δν	Input transition rise or fall rate					10	ns/V
TA	Operating free-air temperature			-40		85	°C

NOTE 4: All unused inputs of the device must be held at the associated V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



# SN74LVCC3245A-EP OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS SCAS773A – JUNE 2004 – REVISED MARCH 2005

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		V <sub>CCB</sub>	MIN	TYP	MAX	UNIT
		$I_{OH} = -100 \mu\text{A}$	3 V	3 V	2.9	3		
		$I_{OH} = -8 \text{ mA}$	2.3 V	3 V	2			
V		10	2.7 V	3 V	2.2	2.5		l
$V_{OHA}$		I <sub>OH</sub> = −12 mA	3 V	3 V	2.4	2.8		V
		04 4	3 V	3 V	2.2	2.6		
		I <sub>OH</sub> = -24 mA	2.7 V	4.5 V	2	2.3		
		$I_{OH} = -100 \mu\text{A}$	3 V	3 V	2.9	3		
		Jan. 12 mA	2.3 V	3 V	2.4			
Vонв		I <sub>OH</sub> = -12 mA	2.7 V	3 V	2.4	2.8		V
		Jan. 24 mA	3 V	3 V	2.2	2.6		
		I <sub>OH</sub> = -24 mA	2.7 V	4.5 V	3.2	4.2		
		$I_{OL} = 100 \mu\text{A}$	3 V	3 V			0.1	
		$I_{OL} = 8 \text{ mA}$	2.3 V	3 V			0.6	
VOLA		$I_{OL} = 12 \text{ mA}$	2.7 V	3 V		0.1	0.5	V
		Jan. 24 mA		3 V		0.2	0.5	
		I <sub>OL</sub> = 24 mA	2.7 V	4.5 V		0.2	0.5	
		$I_{OL} = 100 \mu\text{A}$	3 V	3 V			0.1	
V <sub>OLB</sub>		$I_{OL} = 12 \text{ mA}$	2.3 V	3 V			0.4	V
		I <sub>OL</sub> = 24 mA		3 V		0.2	0.5	V
				4.5 V		0.2	0.5	
1.	Control inputs	W = Voos or CND	3.6 V	3.6 V		±0.1	±1	^
l <sub>l</sub>	Control inputs	V <sub>I</sub> = V <sub>CCA</sub> or GND	3.0 V	5.5 V		±0.1	±1	μΑ
$loz^{\dagger}$	A or B ports	$V_O = V_{CCA/B}$ or GND, $V_I = V_{IL}$ or $V_{IH}$	3.6 V	3.6 V		±0.5	±5	μΑ
		A port = $V_{CCA}$ or GND, $I_{O} = 0$	3.6 V	Open		5	50	
ICCA	B to A	Brant V m CND I 0	0.01/	3.6 V		5	50	μΑ
		B port = $V_{CCB}$ or GND, $I_{O} = 0$	3.6 V	5.5 V		5	50	
		A	0.01/	3.6 V		5	50	
ICCB	A to B	A port = $V_{CCA}$ or GND, $I_{O} = 0$	3.6 V	5.5 V		8	80	μА
	A port	$\frac{V_L}{OE}$ = V <sub>CCA</sub> – 0.6 V, Other inputs at V <sub>CCA</sub> or GND, $\frac{V_C}{OE}$ at GND and DIR at V <sub>CCA</sub>	3.6 V	3.6 V		0.35	0.5	
ΔI <sub>CCA</sub> ‡	ŌĒ	V <sub>I</sub> = V <sub>CCA</sub> - 0.6 V, Other inputs at V <sub>CCA</sub> or GND, DIR at V <sub>CCA</sub>	3.6 V	3.6 V		0.35	0.5	mA
	DIR	$\frac{V_L}{OE}$ = V <sub>CCA</sub> - 0.6 V, Other inputs at V <sub>CCA</sub> or GND,	3.6 V	3.6 V		0.35	0.5	
ΔI <sub>CCB</sub> ‡	B port	$V_L$ = V <sub>CCB</sub> – 2.1 V, Other inputs at V <sub>CCB</sub> or GND, OE at GND and DIR at GND	3.6 V	5.5 V		1	1.5	mA
Ci	Control inputs	V <sub>I</sub> = V <sub>CCA</sub> or GND	Open	Open		4		pF
Cio	A or B ports	VO = VCCA/B or GND	3.3 V	5 V		18.5		pF



<sup>†</sup> For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.
‡ This is the increase in supply current for each input that is at one of the specified voltage levels, rather than 0 V or the associated V<sub>CC</sub>.

# SN74LVCC3245A-EP OCTAL BUS TRANSCEIVER WITH ADJUSTABLE OUTPUT VOLTAGE AND 3-STATE OUTPUTS

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# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 4)

PARAMETER	FROM (INPUT)					= 2.5 V 2 V, = 3.3 V 3 V			V <sub>CCA</sub> TO 3 V <sub>CCB</sub> ± 0.	3.6 V, = 3.3 V	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX			
<sup>t</sup> PHL	Λ.	В	1	9.4	1	6	1	7.1			
<sup>t</sup> PLH	А	В	1	9.1	1	5.3	1	7.2	ns		
<sup>t</sup> PHL	В	A	1	11.2	1	5.8	1	6.4			
<sup>t</sup> PLH		В	А	1	9.9	1	7	1	7.6	ns	
tpZL	ŌE	^	1	14.5	1	9.2	1	9.7			
<sup>t</sup> PZH	ÜE	A	1	12.9	1	9.5	1	9.5	ns		
t <sub>PZL</sub>	ŌĒ		1	13	1	8.1	1	9.2			
<sup>t</sup> PZH	OE	В	1	12.8	1	8.4	1	9.9	ns		
t <sub>PLZ</sub>	<del></del>		1	7.1	1	7	1	6.6			
<sup>t</sup> PHZ	ŌĒ	А	1	6.9	1	7.8	1	6.9	ns		
t <sub>PLZ</sub>			1	8.8	1	7.3	1	7.5			
<sup>t</sup> PHZ	OE	ŌE B		8.9	1	7	1	7.9	ns		

### operating characteristics, V<sub>CCA</sub> = 3.3 V, V<sub>CCB</sub> = 5 V, T<sub>A</sub> = 25°C

	PARAMETER			ONDITIONS	TYP	UNIT
	Davis dissination considers and transcription	Outputs enabled	0 50	4 40 1411-	38	٠, ـ
C <sub>pd</sub>	Power dissipation capacitance per transceiver	Outputs disabled	$C_L = 50,$	f = 10 MHz	4.5	p⊦

## power-up considerations†

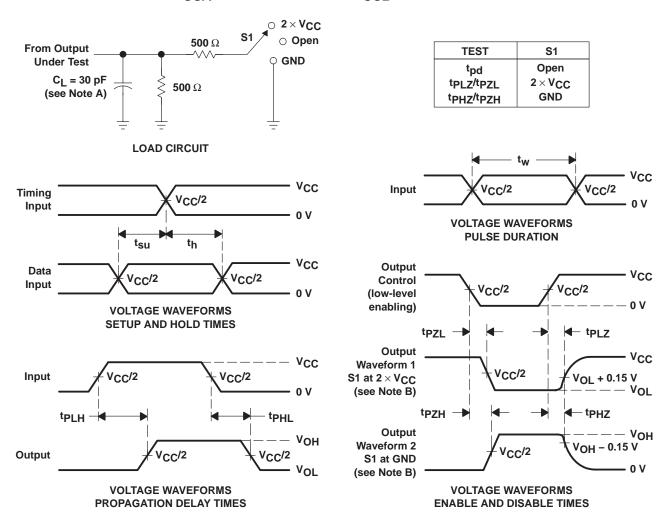
TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins. To guard against such power-up problems, take these precautions:

- 1. Connect ground before any supply voltage is applied.
- 2. Power up the control side of the device (V<sub>CCA</sub> for all four of these devices).
- 3. Tie  $\overline{OE}$  to  $V_{CCA}$  with a pullup resistor so that it ramps with  $V_{CCA}$ .
- 4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with V<sub>CCA</sub>. Otherwise, keep DIR low.

<sup>†</sup> Refer to the TI application report, Texas Instruments Voltage-Level-Translation Devices, literature number SCEA021.



# PARAMETER MEASUREMENT INFORMATION FOR A PORT $V_{CCA}$ = 2.5 V $\pm$ 0.2 V AND $V_{CCB}$ = 3.3 V $\pm$ 0.3 V



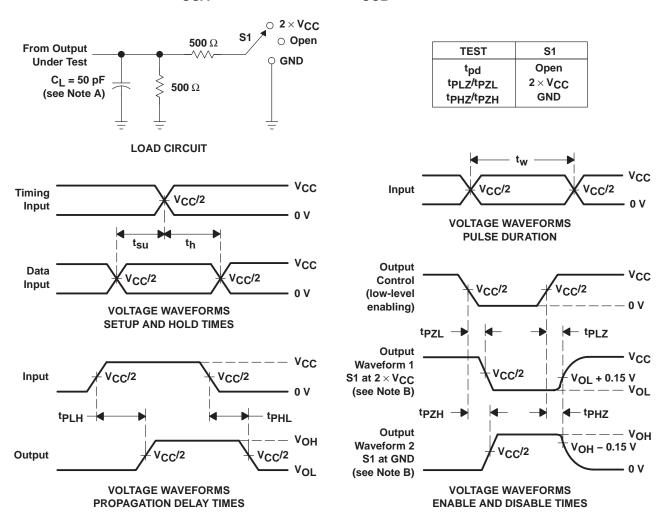
NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq$  2 ns.  $t_f \leq$  2 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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# PARAMETER MEASUREMENT INFORMATION FOR B PORT $V_{CCA}$ = 2.5 V $\pm$ 0.2 V AND $V_{CCB}$ = 3.3 V $\pm$ 0.3 V



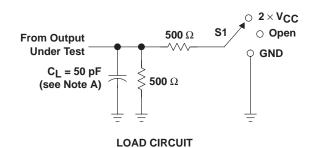
NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq$  2 ns,  $t_f \leq$  2 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

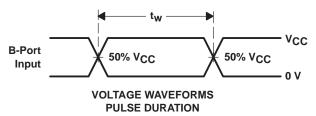
Figure 2. Load Circuit and Voltage Waveforms

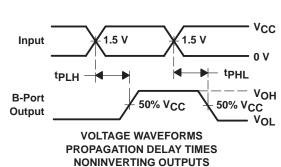


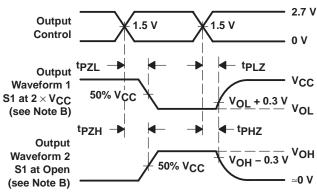
# PARAMETER MEASUREMENT INFORMATION FOR B PORT $V_{CCA} = 3.6 \text{ V}$ AND $V_{CCB} = 5.5 \text{ V}$



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	2×V <sub>CC</sub>
tPHZ/tPZH	Open







VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

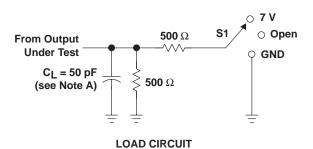
NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

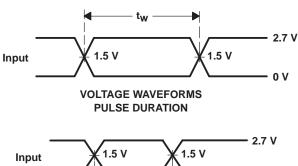
Figure 3. Load Circuit and Voltage Waveforms

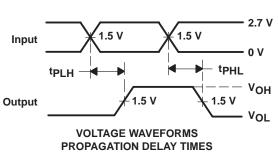
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# PARAMETER MEASUREMENT INFORMATION FOR A AND B PORT $V_{CCA}$ AND $V_{CCB} = 3.6 \text{ V}$

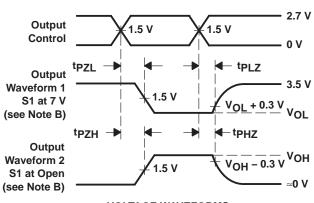


TEST	S1
tPLH/tPHL	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	7 V
tPHZ/tPZH	Open





**NONINVERTING OUTPUTS** 



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns,
- D. The outputs are measured one at a time, with one transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms

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#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
CLVCC3245AIDBREP	Active	Production	SSOP (DB)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LH245AEP
CLVCC3245AIDWREP	Active	Production	SOIC (DW)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LVCC3245A
CLVCC3245AIPWREP	Active	Production	TSSOP (PW)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LH245AEP
V62/05602-01XE	Active	Production	TSSOP (PW)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LH245AEP
V62/05602-01YE	Active	Production	SSOP (DB)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LH245AEP
V62/05602-01ZE	Active	Production	SOIC (DW)   24	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LVCC3245A

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

### PACKAGE OPTION ADDENDUM

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#### OTHER QUALIFIED VERSIONS OF SN74LVCC3245A-EP:

● Catalog : SN74LVCC3245A

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

# **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CLVCC3245AIDBREP	SSOP	DB	24	2000	330.0	16.4	8.2	8.8	2.5	12.0	16.0	Q1
CLVCC3245AIDWREP	SOIC	DW	24	2000	330.0	24.4	10.75	15.7	2.7	12.0	24.0	Q1
CLVCC3245AIPWREP	TSSOP	PW	24	2000	330.0	16.4	6.95	8.3	1.6	8.0	16.0	Q1

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### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CLVCC3245AIDBREP	SSOP	DB	24	2000	353.0	353.0	32.0
CLVCC3245AIDWREP	SOIC	DW	24	2000	350.0	350.0	43.0
CLVCC3245AIPWREP	TSSOP	PW	24	2000	353.0	353.0	32.0



SMALL OUTLINE PACKAGE



### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



DW (R-PDSO-G24)

# PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



### DB (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE

### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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